74LVC126AQuad buffer/line driver with 5 V tolerant input/outputs; 3-stateRev. 8 — 8 April 2014Product data sheet

1. General description

The 74LVC126A consists of four non-inverting buffers/line drivers with 3-state outputs, which are controlled by the output enable input (nOE). A LOW at nOE causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

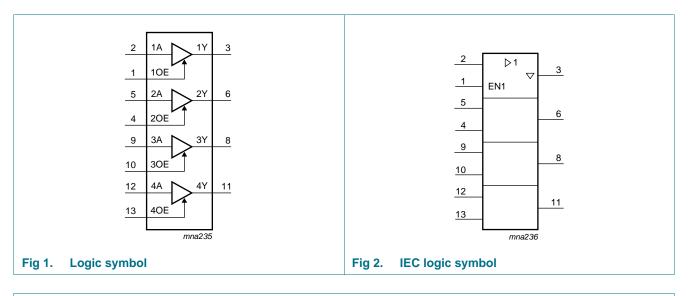
Table 1.Ordering information

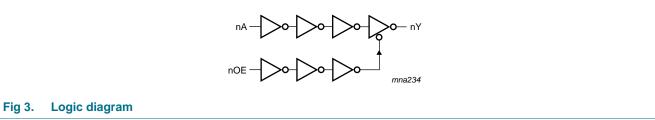
Type number	Package			
	Temperature range	Name	Description	Version
74LVC126AD	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LVC126ADB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1
74LVC126APW	–40 °C to +125 °C	TSSOP14	plastic thin small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC126ABQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1



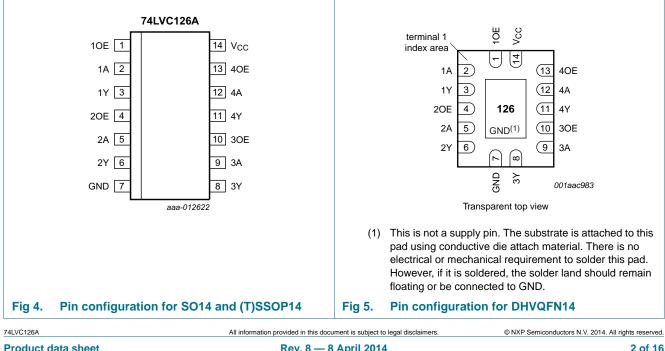
Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

Functional diagram 4.





5. **Pinning information**



5.1 Pinning

5.2 Pin description

Table 2. Pin description						
Symbol	Pin	Description				
10E	1	data enable input (active HIGH)				
1A	2	data input				
1Y	3	data output				
2OE	4	data enable input (active HIGH)				
2A	5	data input				
2Y	6	data output				
GND	7	ground (0 V)				
3Y	8	data output				
3A	9	data input				
3OE	10	data enable input (active HIGH)				
4Y	11	data output				
4A	12	data input				
40E	13	data enable input (active HIGH)				
V _{CC}	14	supply voltage				

6. Functional description

Table 3. Function selection^[1]

Inputs nOE	Output	
nOE	nA	nY
Н	L	L
Н	Н	Н
L	X	Z

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
VI	input voltage		<u>[1]</u>	-0.5	+6.5	V
I _{ОК}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA
Vo	output voltage	output HIGH or LOW-state	[2]	-0.5	V _{CC} + 0.5	V
		output 3-state	[2]	-0.5	+6.5	V
I _O	output current	$V_{O} = 0 V$ to V_{CC}		-	±50	mA

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Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature	[3]	-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \text{ to } +125 \ ^{\circ}C$	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO14 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP14 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN14 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions Symbol Parameter Conditions Min Тур Max Unit Vcc supply voltage 1.65 3.6 V _ functional 1.2 V VI 0 _ 5.5 V input voltage V ٧o output voltage output HIGH or LOW state 0 V_{CC} _ output 3-state 0 5.5 V Tamb ambient temperature in free air -40 _ +125 °C $\Delta t / \Delta V$ input transition rise V_{CC} = 1.65 V to 2.7 V 0 20 ns/V _ and fall rate V_{CC} = 2.7 V to 3.6 V 0 10 ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Max	Min	Max		
V _{IH} HIGH-level input voltage		V _{CC} = 1.2 V	1.08	-	-	1.08	-	V	
	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V		
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V	
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
l		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	

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Symbol	Parameter	Conditions	-40	°C to +8	85 °C	–40 °C t	o +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	V _{CC} - 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
l _l	input leakage current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = 5.5 \text{ V} \text{ or GND}$	-	±0.1	±5	-	±20	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_{O} = 5.5 \text{ V or GND};$	-	±0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0$ V; V_{I} or $V_{O} = 5.5$ V	-	±0.1	±10	-	±20	μA
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA
Δl _{CC}	additional supply current	per input pin; V_{CC} = 1.65 V to 3.6 V; V_I = V _{CC} – 0.6 V; I _O = 0 A	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ V _I = GND to V _{CC}	-	4.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C te	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t _{pd}	propagation delay	nA to nY; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	11.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	5.2	10.8	1.5	12.6	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.8	5.6	1.0	6.6	ns
		V _{CC} = 2.7 V		1.5	2.7	5.2	1.5	6.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.4	4.7	1.0	6.0	ns
t _{en}	enable time	nOE to nY; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	15.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.4	6.7	12.9	2.4	15.0	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		2.0	3.8	7.1	2.0	8.3	ns
		V _{CC} = 2.7 V		1.5	3.1	6.3	1.5	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.1	5.7	1.0	7.5	ns
t _{dis}	disable time	nOE to nY; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	8.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		1.0	3.3	10.0	1.0	11.5	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		0.5	1.8	5.6	0.5	6.5	ns
		V _{CC} = 2.7 V		1.5	3.4	6.7	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.3	2.5	6.0	1.3	7.5	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per buffer; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	capacitance	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	6.0	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	9.3	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	12.2	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

t_{en} is the same as t_{PZL} and t_{PZH}.

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

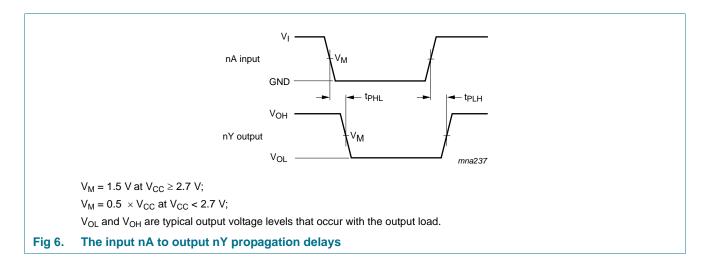
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

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11. AC waveforms



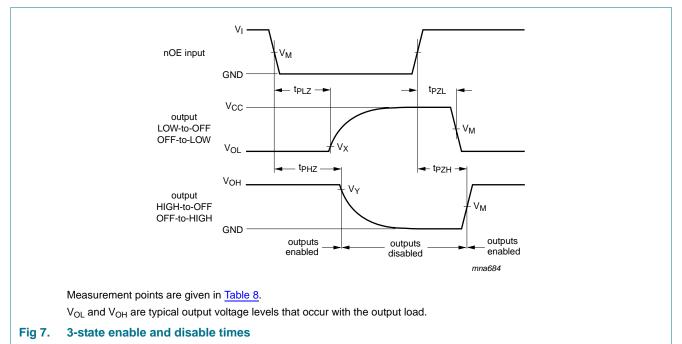
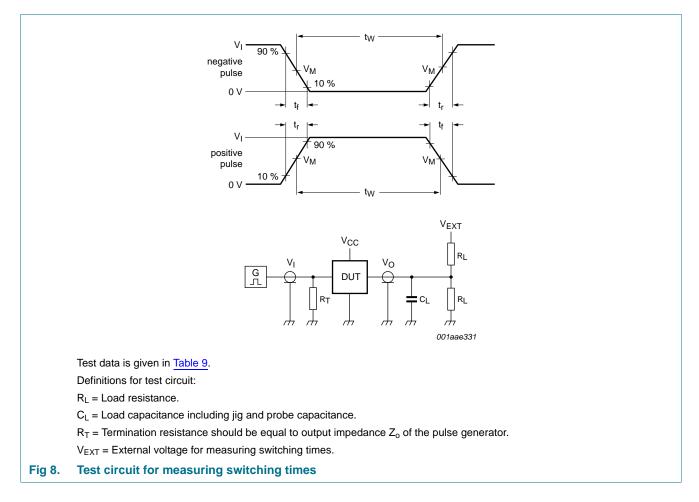


Table 8.Measurement points

Supply voltage	Input	Output				
V _{CC}	V _M	V _M	V _X	V _Y		
V _{CC} < 2.7 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
$V_{CC} \ge 2.7 \text{ V}$	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V		

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Tab	le 9.	Test data

Supply voltage	pply voltage Input Load		V _{EXT}				
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND

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12. Package outline

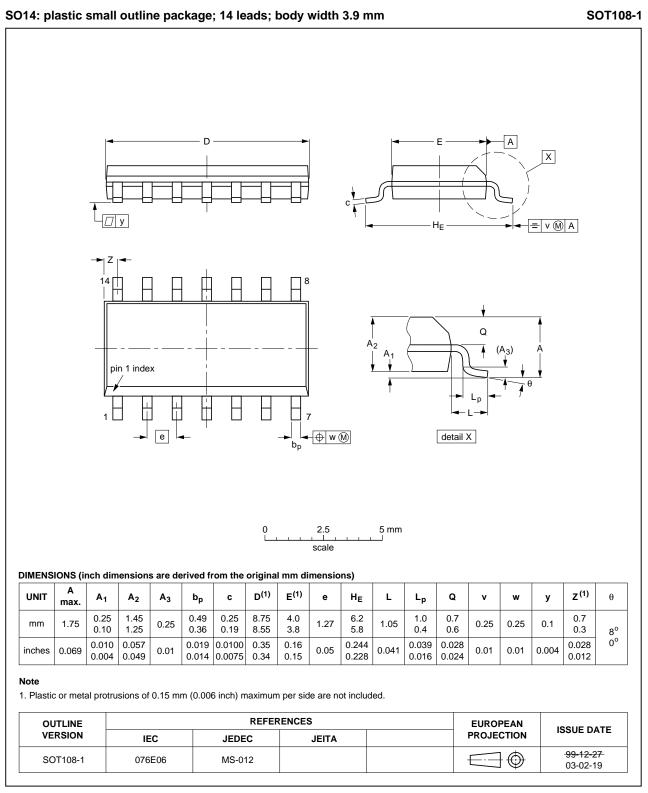


Fig 9. Package outline SOT108-1 (SO14)

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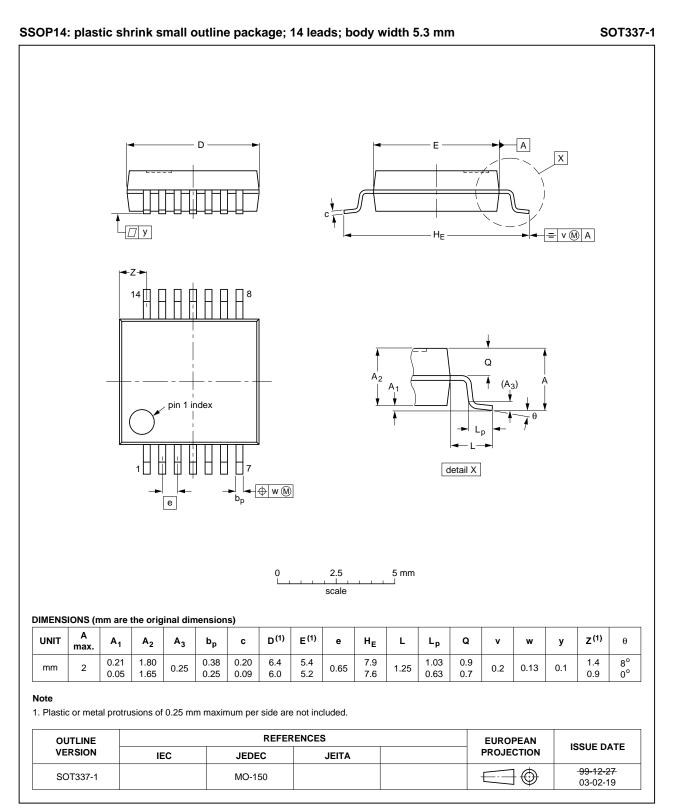


Fig 10. Package outline SOT337-1 (SSOP14)

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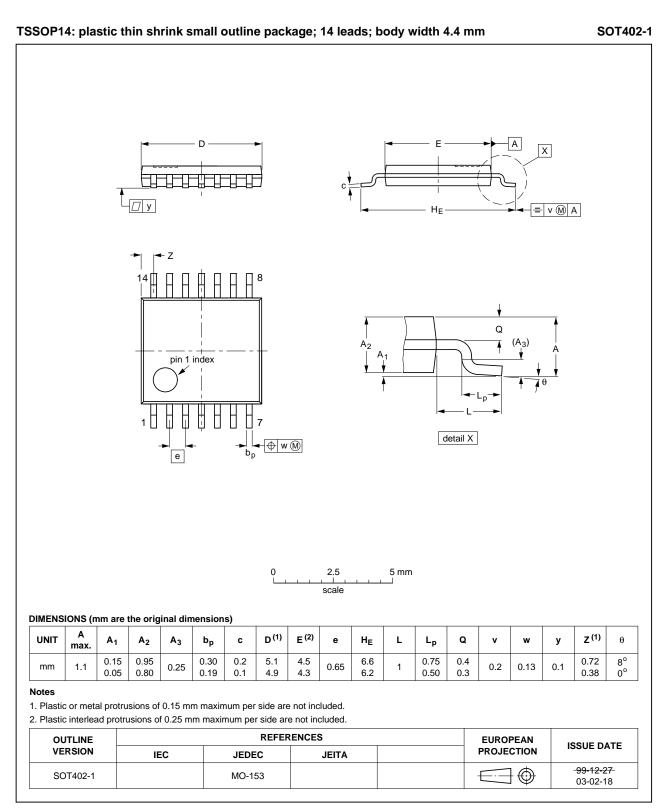
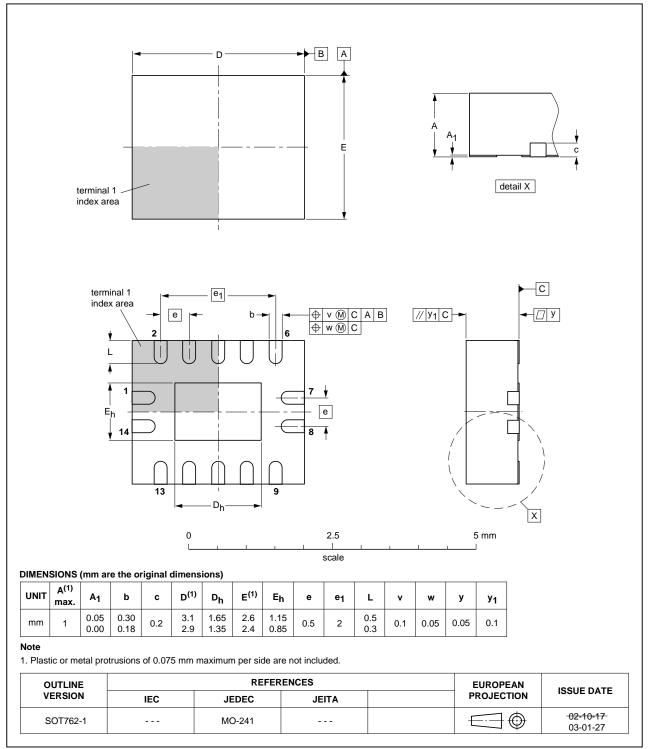


Fig 11. Package outline SOT402-1 (TSSOP14)

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 12. Package outline SOT762-1 (DHVQFN14)

13. Abbreviations

Table 10. Abbreviations					
Acronym	Description				
CDM	Charged Device Model				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
HBM	Human Body Model				
MM	Machine Model				
TTL	Transistor-Transistor Logic				

14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC126A v.8	20140408	Product data sheet	-	74LVC126A v.7
Modifications:	Legal pages	updated.		
74LVC126A v.7	20111209	Product data sheet	-	74LVC126A v.6
Modifications:	Legal pages	updated.		
74LVC126A v.6	20110926	Product data sheet	-	74LVC126A v.5
74LVC126A v.5	20030228	Product specification	-	74LVC126A v.4
74LVC126A v.4	20020308	Product specification	-	74LVC126A v.3
74LVC126A v.3	19980428	Product specification	-	74LVC126A v.2
74LVC126A v.2	19970801	Product specification	-	74LVC126A v.1
74LVC126A v.1	-	-	-	-

74LVC126A Product data sheet

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

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